

## Discription

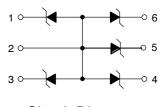
The ESDA6V8AV6 is a 5-channel ultra low capacitance rail clamp ESD protection diodes array. Each channel consists of a pair of ESD diodes that steer positive or negative ESD current to either the positive or negative rail.A zener diode is integrated in to the array between the positive and negative supply rails.In the typical applications, the negative rail pin (assigned as GND) is connected with system ground. The Positive ESD current is steered to the ground through an ESD diode and Zener diode and the positive ESD voltage is clamped to the zener voltage.

#### FEATURES

- Working Peak Reverse Voltage: 5 V
- Low Leakage current: <1uA@3V
- High ESD protection Level: >20kV per HBM
- IEC61000- 4- 2 Level 4 ESD Protection
- IEC61000- 4- 4 Level 4 EFT Protection
- Five separate unidirectional configurations





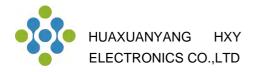


Circuit Diagram

# Product ID Pack Qty(PCS) ESDA6V8AV6 SOT-563 3000

## Absolute Ratings (Tamb=25°C)

Characteristics	Symbol	Ratings	Unit
Peak Pulse Power(8/20µs)	P <sub>PP</sub>	20	W
Peak Pulse Current(8/20µs)	I <sub>PP</sub>	1.6	А
ESD per IEC 61000-4-2(Air)	V <sub>ESD1</sub>	±20kV	kV
ESD per IEC 61000-4-2(Contact)	V <sub>ESD2</sub>	±16kV	kV
Operating Temperature Range	Topr	-55 ~ +125	°C
Storage Temperature Range	Tstg	-55 ~ +150	°C



	Conditions	Minimum	Typical	Maximum	Unit
Ir	V <sub>RWM</sub> =5V			0.5	uA
VF	$I_F = -10 mA$	-0.4	-0.8	-1.25	V
VBR	IT=1mA	6.2	6.8	7.2	V
Vc	$I_{PP}=1A$ , $tp = 8/20us$ , note1			12	V
ve ve	$I_{PP}=1.6A$ , $tp = 8/20us$ , note1			14.4	V
C	Pin1 to 2 $V_R = 0V$ , f = 1MHz		9		pF

#### Electrical characteristics (T<sub>A</sub>=25 °C, unless otherwise noted)

Note1: Surge current waveform per Figure 1.

## **Typical Characteristics**

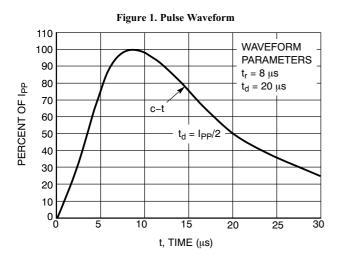
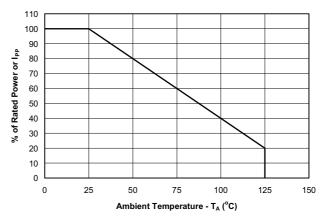


Figure 2. Power Derating Curve



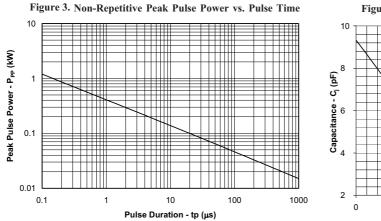
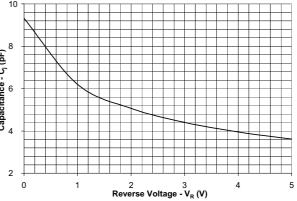


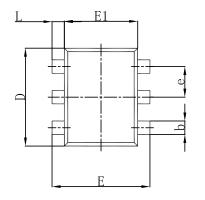
Figure 4. Junction Capacitance vs. Reverse Voltage

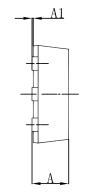


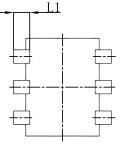


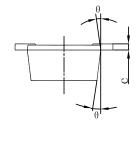
# ESDA6V8AV6 ESD PROTECTION DIODE

## **SOT-563 Package Outline Dimensions**



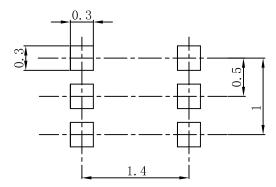






Symbol	Dimensions in Millimeters		Dimensions in Inches	
	Min.	Max.	Min.	Max.
A	0.525	0.600	0.021	0.024
A1	0.000	0.050	0.000	0.002
е	0.450	0.550	0.018	0.022
с	0.090	0.160	0.004	0.006
D	1.500	1.700	0.059	0.067
b	0.170	0.270	0.007	0.011
E1	1.100	1.300	0.043	0.051
E	1.500	1.700	0.059	0.067
L	0.100	0.300	0.004	0.012
L1	0.200	0.400	0.008	0.016
θ		$7^{0}$ REF. $7^{0}$ REF.		7 <sup>0</sup> REF.

## SOT-563 Suggested Pad Layout



Note:

1.Controlling dimension:in millimeters.

2.General tolerance:±0.05mm.

3. The pad layout is for reference purposes only.



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